IITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

S.A. Kulchin

Attorney Docket No.: KULS122520

Application No.: 10/816,070

Group Art Unit: 3673

Filed:

March 30, 2004

Examiner: Jong S. Lee

Title:

SOIL NAILING SYSTEM

AMENDMENT TRANSMITTAL LETTER

Seattle, Washington 98101

January 31, 2005

TO THE COMMISSIONER FOR PATENTS:

Amendment Transmittal A.

Transmitted herewith is an amendment in the above-identified application.

X

- 1. No additional claim fee is required, as shown below.
- 2. The claim fee has been calculated as shown below.

COMPUTATION OF FEE FOR CLAIMS AS AMENDED

	Claims		Highest		•				
	Remaining		Number						
	After		Previously		Present				Additional
	Amendment		Paid For		Extra		Rate		Fee
Total Claims	5	-	20	=	0	X	25	=	0
Independent Claims	2	-	3 .	=	0	X	100	=	0
4-14	TOTAL								\$0

B. Additional Fee Charges or Credit for Overpayment

The Commissioner is hereby authorized to charge any fees under 37 C.F.R. §§ 1.16, 1.17 and 1.18 which may be required during the entire pendency of the application, or credit any overpayment, to Deposit Account No. 03-1740. This authorization also hereby includes a request for any extensions of time of the appropriate length required upon the filing of any reply during the entire prosecution of this application.

Respectfully submitted,

CHRISTENSEN O'CONNOR JOHNSON KINDNESSPLLC

Łee E. Johnson

Registration No. 22,946 Direct Dial No. 206.695.1701

I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first class mail with postage thereon fully prepaid and addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the below date.

Date: January 31, 2005

I FI:mmw

LAW OFFICES OF CHRISTENSEN O'CONNOR JOHNSON KINDNESS**LLC 1420 Fifth Avenue Suite 2800 Seattle, Washington 98101 206.682.8100



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TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

This paper is filed in reply to the communication dated November 2, 2004, from the Examiner in charge of the above-identified application. Please amend the claims as follows: